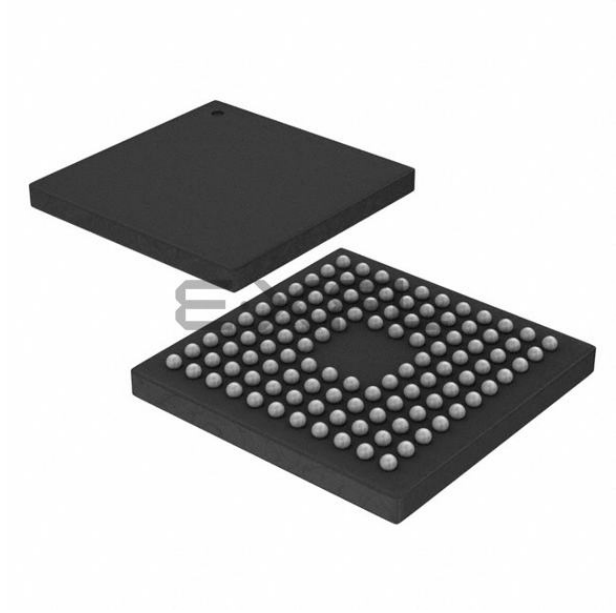
Silicon Labs - EFM32GG11B310F2048GL112-A Datasheet



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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	ARM® Cortex®-M4
Core Size	32-Bit Single-Core
Speed	72MHz
Connectivity	CANbus, EBI/EMI, I²C, IrDA, LINbus, SmartCard, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, LCD, POR, PWM, WDT
Number of I/O	90
Program Memory Size	2MB (2M x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	384K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.8V
Data Converters	A/D 16x12b SAR; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	112-LFBGA
Supplier Device Package	112-BGA (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/silicon-labs/efm32gg11b310f2048gl112-a

4.1.7.3 Current Consumption 1.8 V without DC-DC Converter

Unless otherwise indicated, typical conditions are: VREGVDD = AVDD = DVDD = 1.8 V. T = 25 °C. DCDC is off. Minimum and maximum values in this table represent the worst conditions across supply voltage and process variation at T = 25 °C.

Table 4.9. Current Consumption 1.8 V without DC-DC Converter

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Current consumption in EM0 mode with all peripherals disabled	I_{ACTIVE}	72 MHz HFRCO, CPU running Prime from flash	—	120	—	µA/MHz
		72 MHz HFRCO, CPU running while loop from flash	—	120	—	µA/MHz
		72 MHz HFRCO, CPU running CoreMark loop from flash	—	140	—	µA/MHz
		50 MHz crystal, CPU running while loop from flash	—	122	—	µA/MHz
		48 MHz HFRCO, CPU running while loop from flash	—	122	—	µA/MHz
		32 MHz HFRCO, CPU running while loop from flash	—	124	—	µA/MHz
		26 MHz HFRCO, CPU running while loop from flash	—	126	—	µA/MHz
		16 MHz HFRCO, CPU running while loop from flash	—	131	—	µA/MHz
		1 MHz HFRCO, CPU running while loop from flash	—	315	—	µA/MHz
Current consumption in EM0 mode with all peripherals disabled and voltage scaling enabled	I_{ACTIVE_VS}	19 MHz HFRCO, CPU running while loop from flash	—	107	—	µA/MHz
		1 MHz HFRCO, CPU running while loop from flash	—	259	—	µA/MHz
Current consumption in EM1 mode with all peripherals disabled	I_{EM1}	72 MHz HFRCO	—	57	—	µA/MHz
		50 MHz crystal	—	59	—	µA/MHz
		48 MHz HFRCO	—	59	—	µA/MHz
		32 MHz HFRCO	—	61	—	µA/MHz
		26 MHz HFRCO	—	63	—	µA/MHz
		16 MHz HFRCO	—	68	—	µA/MHz
		1 MHz HFRCO	—	252	—	µA/MHz
Current consumption in EM1 mode with all peripherals disabled and voltage scaling enabled	I_{EM1_VS}	19 MHz HFRCO	—	55	—	µA/MHz
		1 MHz HFRCO	—	207	—	µA/MHz
Current consumption in EM2 mode, with voltage scaling enabled	I_{EM2_VS}	Full 512 kB RAM retention and RTCC running from LFXO	—	3.7	—	µA
		Full 512 kB RAM retention and RTCC running from LFRCO	—	4.0	—	µA
		16 kB (1 bank) RAM retention and RTCC running from LFRCO[2]	—	2.5	—	µA

4.1.11 Flash Memory Characteristics[5]

Table 4.19. Flash Memory Characteristics[5]

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Flash erase cycles before failure	EC_{FLASH}		10000	—	—	cycles
Flash data retention	RET_{FLASH}	T ≤ 85 °C	10	—	—	years
		T ≤ 125 °C	10	—	—	years
Word (32-bit) programming time	t_{W_PROG}	Burst write, 128 words, average time per word	20	26.2	32	µs
		Single word	59	68.7	83	µs
Page erase time[4]	t_{PERASE}		20	26.8	35	ms
Mass erase time[1]	t_{MERASE}		20	26.9	35	ms
Device erase time[2 3]	t_{DERASE}	T ≤ 85 °C	—	80.7	95	ms
		T ≤ 125 °C	—	80.7	100	ms
Erase current[6]	I_{ERASE}	Page Erase	—	—	1.7	mA
		Mass or Device Erase	—	—	2.1	mA
Write current[6]	I_{WRITE}		—	—	3.9	mA
Supply voltage during flash erase and write	V_{FLASH}		1.62	—	3.6	V

Note:

1. Mass erase is issued by the CPU and erases all flash.
2. Device erase is issued over the AAP interface and erases all flash, SRAM, the Lock Bit (LB) page, and the User data page Lock Word (ULW).
3. From setting the DEVICEERASE bit in AAP_CMD to 1 until the ERASEBUSY bit in AAP_STATUS is cleared to 0. Internal setup and hold times for flash control signals are included.
4. From setting the ERASEPAGE bit in MSC_WRITECMD to 1 until the BUSY bit in MSC_STATUS is cleared to 0. Internal setup and hold times for flash control signals are included.
5. Flash data retention information is published in the Quarterly Quality and Reliability Report.
6. Measured at 25 °C.

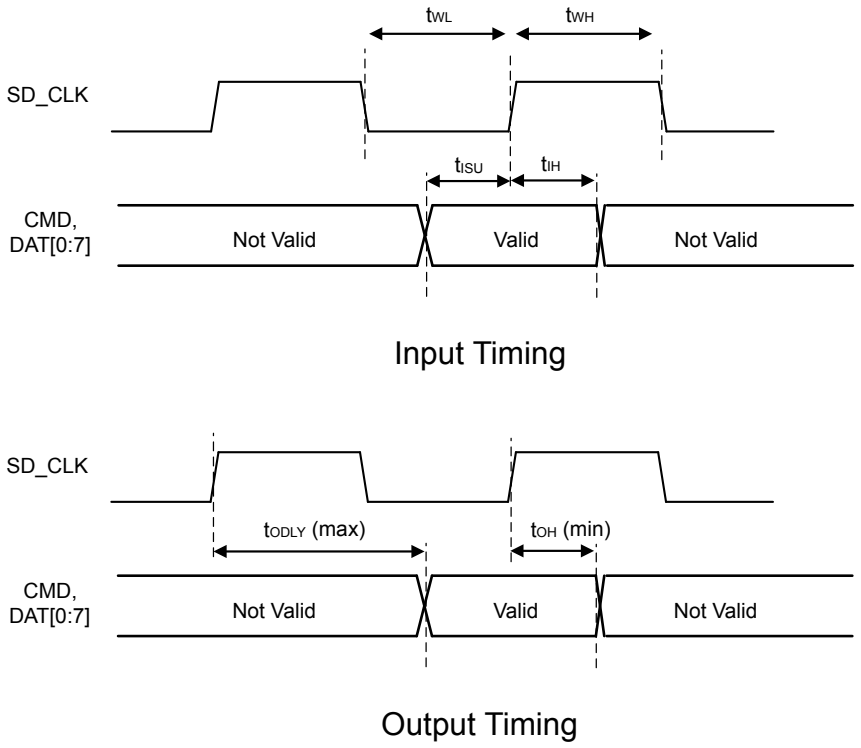

Figure 4.18. SDIO MMC SDR Mode Timing

4.2 Typical Performance Curves

Typical performance curves indicate typical characterized performance under the stated conditions.

5. Pin Definitions

5.1 EFM32GG11B8xx in BGA192 Device Pinout

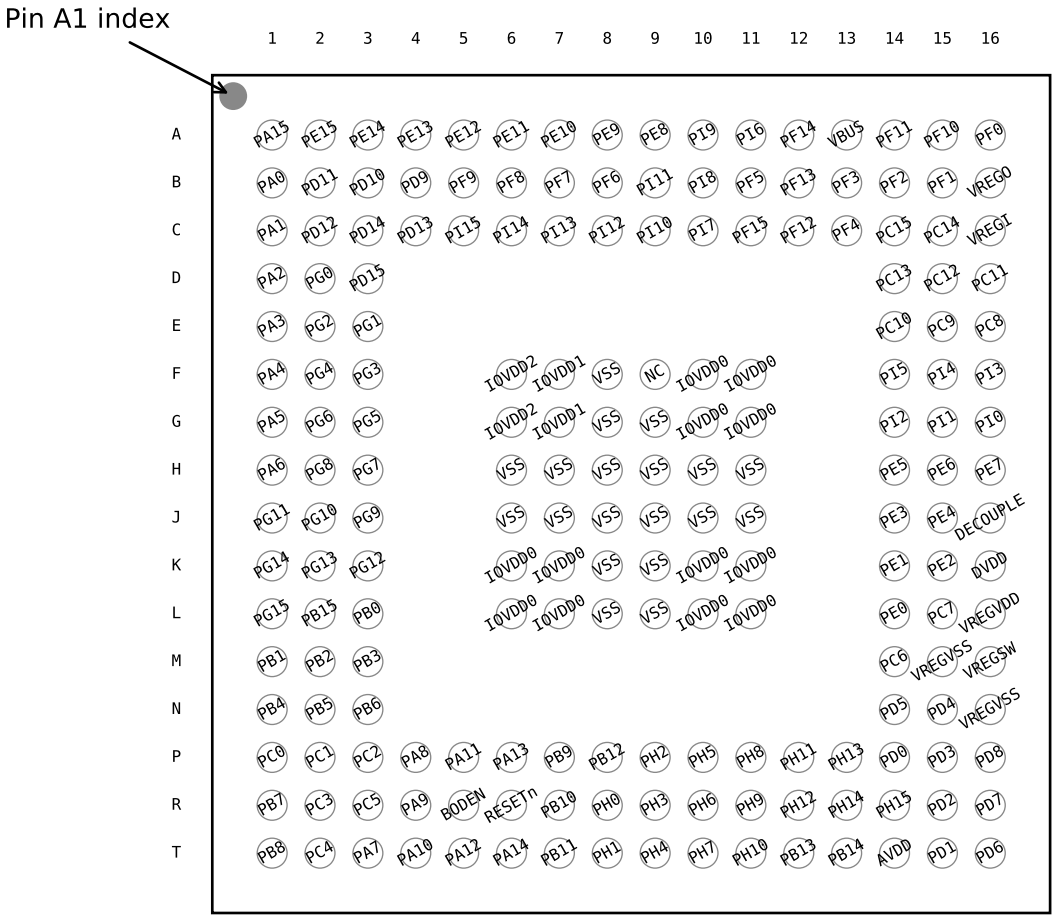

Figure 5.1. EFM32GG11B8xx in BGA192 Device Pinout

The following table provides package pin connections and general descriptions of pin functionality. For detailed information on the supported features for each GPIO pin, see 5.20 GPIO Functionality Table or 5.21 Alternate Functionality Overview.

Table 5.1. EFM32GG11B8xx in BGA192 Device Pinout

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
PA15	A1	GPIO	PE15	A2	GPIO
PE14	A3	GPIO	PE13	A4	GPIO
PE12	A5	GPIO	PE11	A6	GPIO
PE10	A7	GPIO	PE9	A8	GPIO
PE8	A9	GPIO	PI9	A10	GPIO (5V)
PI6	A11	GPIO (5V)	PF14	A12	GPIO (5V)

5.2 EFM32GG11B8xx in BGA152 Device Pinout

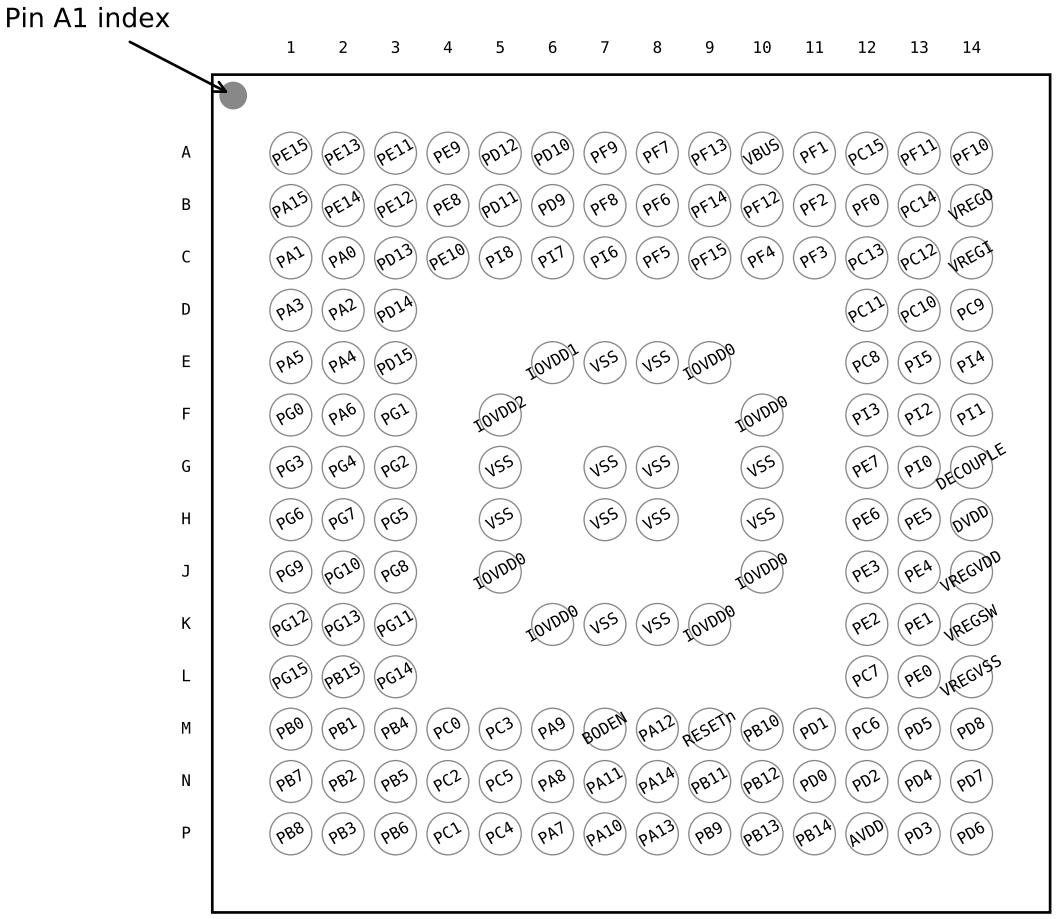

Figure 5.2. EFM32GG11B8xx in BGA152 Device Pinout

The following table provides package pin connections and general descriptions of pin functionality. For detailed information on the supported features for each GPIO pin, see 5.20 GPIO Functionality Table or 5.21 Alternate Functionality Overview.

Table 5.2. EFM32GG11B8xx in BGA152 Device Pinout

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
PE15	A1	GPIO	PE13	A2	GPIO
PE11	A3	GPIO	PE9	A4	GPIO
PD12	A5	GPIO	PD10	A6	GPIO
PF9	A7	GPIO	PF7	A8	GPIO
PF13	A9	GPIO (5V)	VBUS	A10	USB VBUS signal and auxiliary input to 5 V regulator.
PF1	A11	GPIO (5V)	PC15	A12	GPIO (5V)
PF11	A13	GPIO (5V)	PF10	A14	GPIO (5V)

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
PF11	A13	GPIO (5V)	PA15	B1	GPIO
PE13	B2	GPIO	PE11	B3	GPIO
PE8	B4	GPIO	PD12	B5	GPIO
PD10	B6	GPIO	PF8	B7	GPIO
PF6	B8	GPIO	PF3	B9	GPIO
PF1	B10	GPIO (5V)	PF12	B11	GPIO
VBUS	B12	USB VBUS signal and auxiliary input to 5 V regulator.	PF10	B13	GPIO (5V)
PA1	C1	GPIO	PA0	C2	GPIO
PE10	C3	GPIO	PD13	C4	GPIO (5V)
VSS	C5 C8 H3 J3 K11 K12 L12 L13 M8 M11 N8	Ground	IOVDD1	C6	Digital IO power supply 1.
PF9	C7	GPIO	IOVDD0	C9 J11 K3 L11 L14	Digital IO power supply 0.
PF0	C10	GPIO (5V)	PE4	C11	GPIO
PC14	C12	GPIO (5V)	PC15	C13	GPIO (5V)
PA3	D1	GPIO	PA2	D2	GPIO
PB15	D3	GPIO (5V)	PE5	D11	GPIO
PC12	D12	GPIO (5V)	PC13	D13	GPIO (5V)
PA6	E1	GPIO	PA5	E2	GPIO
PA4	E3	GPIO	PE6	E11	GPIO
PC10	E12	GPIO (5V)	PC11	E13	GPIO (5V)
PB0	F1	GPIO	PB1	F2	GPIO
PB2	F3	GPIO	PE7	F11	GPIO
PC8	F12	GPIO (5V)	PC9	F13	GPIO (5V)
PB3	G1	GPIO	PB4	G2	GPIO
IOVDD2	G3	Digital IO power supply 2.	PE0	G11	GPIO (5V)
PE1	G12	GPIO (5V)	PE3	G13	GPIO
PB5	H1	GPIO	PB6	H2	GPIO
DVDD	H11	Digital power supply.	PE2	H12	GPIO
PC7	H13	GPIO	PD14	J1	GPIO (5V)

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
PE8	B4	GPIO	PD11	B5	GPIO
PF8	B6	GPIO	PF6	B7	GPIO
VBUS	B8	USB VBUS signal and auxiliary input to 5 V regulator.	PE5	B9	GPIO
VREGI	B10	Input to 5 V regulator.	VREGO	B11	Decoupling for 5 V regulator and regulator output. Power for USB PHY in USB-enabled OPNs
PA1	C1	GPIO	PA0	C2	GPIO
PE10	C3	GPIO	PD13	C4	GPIO (5V)
PD12	C5	GPIO	PF9	C6	GPIO
VSS	C7 D4 F9 G3 G9 H6 K4 K7 K10 L7	Ground	PF2	C8	GPIO
PE6	C9	GPIO	PC10	C10	GPIO (5V)
PC11	C11	GPIO (5V)	PA3	D1	GPIO
PA2	D2	GPIO	PB15	D3	GPIO (5V)
IOVDD1	D5	Digital IO power supply 1.	PD9	D6	GPIO
IOVDD0	D7 G8 H7 L4	Digital IO power supply 0.	PF1	D8	GPIO (5V)
PE7	D9	GPIO	PC8	D10	GPIO (5V)
PC9	D11	GPIO (5V)	PA6	E1	GPIO
PA5	E2	GPIO	PA4	E3	GPIO
PB0	E4	GPIO	PF0	E8	GPIO (5V)
PE0	E9	GPIO (5V)	PE1	E10	GPIO (5V)
PE3	E11	GPIO	PB1	F1	GPIO
PB2	F2	GPIO	PB3	F3	GPIO
PB4	F4	GPIO	DVDD	F8	Digital power supply.
PE2	F10	GPIO	DECOUPLE	F11	Decouple output for on-chip voltage regulator. An external decoupling capacitor is required at this pin.
PB5	G1	GPIO	PB6	G2	GPIO
IOVDD2	G4	Digital IO power supply 2.	PC6	G10	GPIO
PC7	G11	GPIO	PC0	H1	GPIO (5V)
PC2	H2	GPIO (5V)	PD14	H3	GPIO (5V)
PA7	H4	GPIO	PA8	H5	GPIO

5.13 EFM32GG11B5xx in QFP64 Device Pinout

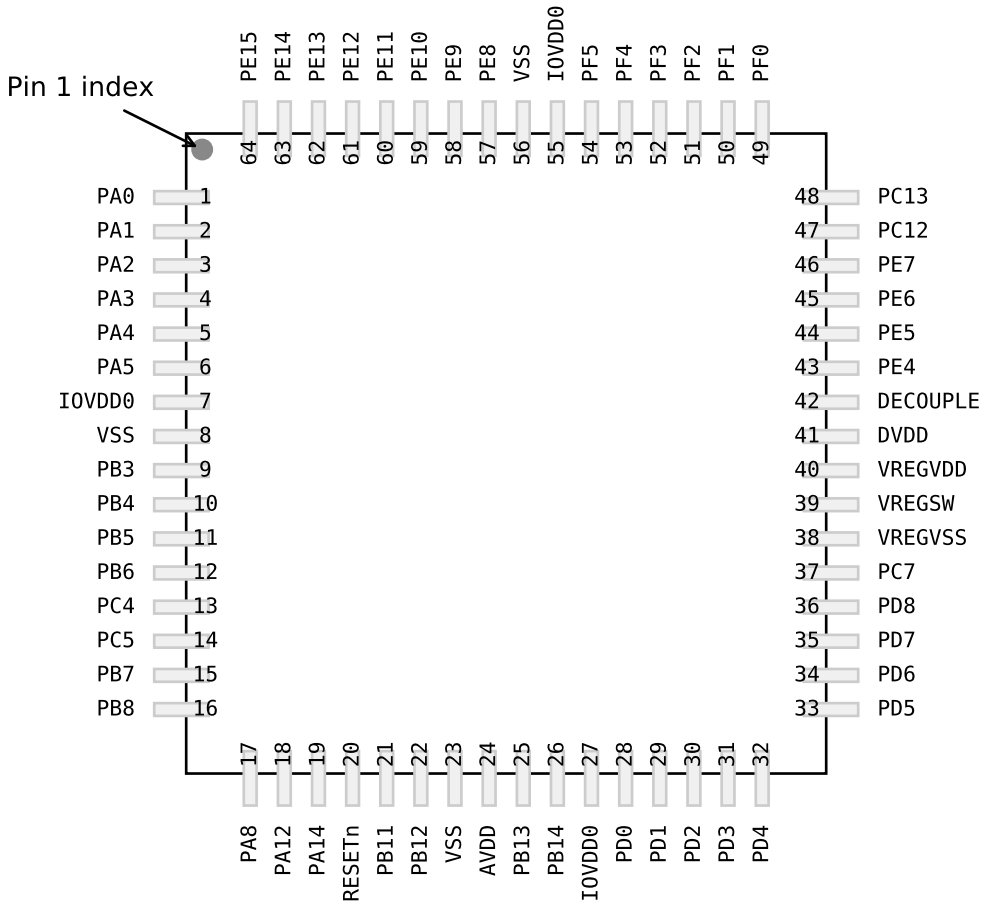

Figure 5.13. EFM32GG11B5xx in QFP64 Device Pinout

The following table provides package pin connections and general descriptions of pin functionality. For detailed information on the supported features for each GPIO pin, see 5.20 GPIO Functionality Table or 5.21 Alternate Functionality Overview.

Table 5.13. EFM32GG11B5xx in QFP64 Device Pinout

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
PA0	1	GPIO	PA1	2	GPIO
PA2	3	GPIO	PA3	4	GPIO
PA4	5	GPIO	PA5	6	GPIO
IOVDD0	7 27 55	Digital IO power supply 0.	VSS	8 23 56	Ground
PB3	9	GPIO	PB4	10	GPIO
PB5	11	GPIO	PB6	12	GPIO

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
PB6	12	GPIO	PC4	13	GPIO
PC5	14	GPIO	PB7	15	GPIO
PB8	16	GPIO	PA8	17	GPIO
PA12	18	GPIO (5V)	PA13	19	GPIO (5V)
PA14	20	GPIO	RESETn	21	Reset input, active low. To apply an external reset source to this pin, it is required to only drive this pin low during reset, and let the internal pull-up ensure that reset is released.
PB11	22	GPIO	PB12	23	GPIO
AVDD	24	Analog power supply.	PB13	25	GPIO
PB14	26	GPIO	PD0	28	GPIO (5V)
PD1	29	GPIO	PD2	30	GPIO (5V)
PD3	31	GPIO	PD4	32	GPIO
PD5	33	GPIO	PD6	34	GPIO
PD8	35	GPIO	VREGVSS	36	Voltage regulator VSS
VREGSW	37	DCDC regulator switching node	VREGVDD	38	Voltage regulator VDD input
DVDD	39	Digital power supply.	DECOUPLE	40	Decouple output for on-chip voltage regulator. An external decoupling capacitor is required at this pin.
PE4	41	GPIO	PE5	42	GPIO
PE6	43	GPIO	PE7	44	GPIO
VREGI	45	Input to 5 V regulator.	VREGO	46	Decoupling for 5 V regulator and regulator output. Power for USB PHY in USB-enabled OPNs
PF10	47	GPIO (5V)	PF11	48	GPIO (5V)
PF0	49	GPIO (5V)	PF1	50	GPIO (5V)
PF2	51	GPIO	VBUS	52	USB VBUS signal and auxiliary input to 5 V regulator.
PF12	53	GPIO	PF5	54	GPIO
PE8	56	GPIO	PE9	57	GPIO
PE10	58	GPIO	PE11	59	GPIO
PE12	60	GPIO	PE13	61	GPIO
PE14	62	GPIO	PE15	63	GPIO
PA15	64	GPIO			

Note:

1. GPIO with 5V tolerance are indicated by (5V).

GPIO Name	Pin Alternate Functionality / Description				
	Analog	EBI	Timers	Communication	Other
PD15		EBI_NANDREn #1	TIM2_CDTI2 #1 TIM3_CC0 #7 WTIM0_CDTI0 #1 PCNT1_S0IN #2	ETH_TSUEXTCLK #1 CAN0_TX #5 US5_CTS #1 I2C0_SCL #3	
PC13	VDAC0_OUT1ALT / OPA1_OUTALT #1 BUSACMP1Y BUSACMP1X	EBI_ARDY #4	TIM0_CDTI0 #1 TIM1_CC0 #0 TIM1_CC2 #4 TIM5_CC2 #5 WTIM3_CC2 #2 PCNT0_S0IN #0 PCNT2_S1IN #4	US0_CTS #3 US1_RTS #4 US2_RTS #4 U0_CTS #3 U1_RX #0 I2C2_SCL #6	LES_CH13 PRS_CH21 #1 ACMP3_O #3
PC12	VDAC0_OUT1ALT / OPA1_OUTALT #0 BUSACMP1Y BUSACMP1X		TIM1_CC3 #0 TIM5_CC1 #5 WTIM3_CC1 #2 PCNT2_S0IN #4	CAN1_RX #4 US0_RTS #3 US1_CTS #4 US2_CTS #4 U0_RTS #3 U1_TX #0 I2C2_SDA #6	CMU_CLK0 #1 LES_CH12 PRS_CH20 #1
PC11	BUSACMP1Y BUSACMP1X	EBI_ALE #4 EBI_ALE #5 EBI_A23 #1	TIM5_CC0 #5 WTIM3_CC0 #2	CAN1_TX #4 US0_TX #2 I2C1_SDA #4	LES_CH11 PRS_CH19 #1
PA3	BUSAY BUSBX LCD_SEG16	EBI_AD12 #0 EBI_VSNC #3	TIM0_CDTI0 #0 TIM3_CC0 #5	ETH_RMIIREFCLK #0 ETH_MIITXD1 #0 SDIO_DAT3 #1 US3_CS #0 U0_TX #2 QSPI0_DQ1 #1	CMU_CLK2 #1 CMU_CLKI0 #1 CMU_CLK2 #4 LES_ALTEX2 PRS_CH9 #1 ETM_TD1 #3
PG2	BUSACMP2Y BUSACMP2X	EBI_AD02 #2	TIM6_CC2 #0 TIM2_CDTI2 #3 WTIM0_CC0 #2 LETIM1_OUT0 #7	ETH_MIITXD2 #1 US3_CLK #4 QSPI0_DQ1 #2	CMU_CLK0 #3
PG1	BUSACMP2Y BUSACMP2X	EBI_AD01 #2	TIM6_CC1 #0 TIM2_CDTI1 #3 WTIM0_CDTI2 #1 LETIM1_OUT1 #6	ETH_MIITXD3 #1 US3_RX #4 QSPI0_DQ0 #2	CMU_CLK1 #3
PC10	BUSACMP1Y BUSACMP1X	EBI_A10 #2 EBI_A22 #1	TIM2_CC2 #2 TIM5_CC2 #4 WTIM3_CC2 #1	CAN1_TX #3 US0_RX #2	LES_CH10 PRS_CH18 #1
PC9	BUSACMP1Y BUSACMP1X	EBI_A09 #2 EBI_A21 #1 EBI_A27 #3	TIM2_CC1 #2 TIM5_CC1 #4 WTIM3_CC1 #1	CAN1_RX #3 US0_CLK #2	LES_CH9 PRS_CH5 #0 GPIO_EM4WU2
PC8	BUSACMP1Y BUSACMP1X	EBI_A08 #2 EBI_A15 #0 EBI_A20 #1 EBI_A26 #3	TIM2_CC0 #2 TIM5_CC0 #4 WTIM3_CC0 #1	US0_CS #2	LES_CH8 PRS_CH4 #0
PA4	BUSBY BUSAX LCD_SEG17	EBI_AD13 #0 EBI_HSNC #3	TIM0_CDTI1 #0 TIM3_CC1 #5	ETH_RMIICRSDV #0 ETH_MIITXD0 #0 SDIO_DAT4 #1 US3_CTS #0 U0_RX #2 QSPI0_DQ2 #1	LES_ALTEX3 PRS_CH16 #0 ETM_TD2 #3
PG4	BUSACMP2Y BUSACMP2X	EBI_AD04 #2	TIM6_CDTI1 #0 WTIM0_CC2 #2	ETH_MIITXD0 #1 US3_CTS #4 QSPI0_DQ3 #2	

Alternate	LOCATION		
Functionality	0 - 3	4 - 7	Description
PRS_CH20	0: PB4 1: PC12 2: PE2		Peripheral Reflex System PRS, channel 20.
PRS_CH21	0: PB5 1: PC13 2: PB11		Peripheral Reflex System PRS, channel 21.
PRS_CH22	0: PB7 1: PE0 2: PF6		Peripheral Reflex System PRS, channel 22.
PRS_CH23	0: PB8 1: PE1 2: PF7		Peripheral Reflex System PRS, channel 23.
QSPI0_CS0	0: PF7 1: PA0 2: PG9		Quad SPI 0 Chip Select 0.
QSPI0_CS1	0: PF8 1: PA1 2: PG10		Quad SPI 0 Chip Select 1.
QSPI0_DQ0	0: PD9 1: PA2 2: PG1		Quad SPI 0 Data 0.
QSPI0_DQ1	0: PD10 1: PA3 2: PG2		Quad SPI 0 Data 1.
QSPI0_DQ2	0: PD11 1: PA4 2: PG3		Quad SPI 0 Data 2.
QSPI0_DQ3	0: PD12 1: PA5 2: PG4		Quad SPI 0 Data 3.
QSPI0_DQ4	0: PE8 1: PB3 2: PG5		Quad SPI 0 Data 4.
QSPI0_DQ5	0: PE9 1: PB4 2: PG6		Quad SPI 0 Data 5.
QSPI0_DQ6	0: PE10 1: PB5 2: PG7		Quad SPI 0 Data 6.

Alternate	LOCATION		
Functionality	0 - 3	4 - 7	Description
US5_RX	0: PE9 1: PA7 2: PB1 3: PH11		USART5 Asynchronous Receive. USART5 Synchronous mode Master Input / Slave Output (MISO).
US5_TX	0: PE8 1: PA6 2: PF15 3: PH10		USART5 Asynchronous Transmit. Also used as receive input in half duplex communication. USART5 Synchronous mode Master Output / Slave Input (MOSI).
USB_DM	0: PF10		USB D- pin.
USB_DP	0: PF11		USB D+ pin.
USB_ID	0: PF12		USB ID pin.
USB_VBUSEN	0: PF5		USB 5 V VBUS enable.
VDAC0_EXT	0: PD6		Digital to analog converter VDAC0 external reference input pin.
VDAC0_OUT0 / OPA0_OUT	0: PB11		Digital to Analog Converter DAC0 output channel number 0.
VDAC0_OUT0ALT / OPA0_OUTALT	0: PC0 1: PC1 2: PC2 3: PC3	4: PD0	Digital to Analog Converter DAC0 alternative output for channel 0.
VDAC0_OUT1 / OPA1_OUT	0: PB12		Digital to Analog Converter DAC0 output channel number 1.
VDAC0_OUT1ALT / OPA1_OUTALT	0: PC12 1: PC13 2: PC14 3: PC15	4: PD1	Digital to Analog Converter DAC0 alternative output for channel 1.
WTIM0_CC0	0: PE4 1: PA6 2: PG2 3: PG8	4: PC15 5: PB0 6: PB3 7: PC1	Wide timer 0 Capture Compare input / output channel 0.
WTIM0_CC1	0: PE5 1: PD13 2: PG3 3: PG9	4: PF0 5: PB1 6: PB4 7: PC2	Wide timer 0 Capture Compare input / output channel 1.

Table 5.23. ACMP0 Bus and Pin Mapping

Port	Bus	CH31	CH30	CH29	CH28	CH27	CH26	CH25	CH24	CH23	CH22	CH21	CH20	CH19	CH18	CH17	CH16	CH15	CH14	CH13	CH12	CH11	CH10	CH9	CH8	CH7	CH6	CH5	CH4	CH3	CH2	CH1	CH0
APORT0X	BUSACMP0X																									PC7	PC6	PC5	PC4	PC3	PC2	PC1	PC0
APORT0Y	BUSACMP0Y																									PC7	PC6	PC5	PC4	PC3	PC2	PC1	PC0
APORT1X	BUSAX		PB14		PB12		PB10				PB6		PB4		PB2		PB0		PA14		PA12		PA10		PA8		PA6		PA4		PA2		PA0
APORT1Y	BUSAY	PB15		PB13		PB11		PB9				PB5		PB3		PB1		PA15		PA13		PA11		PA9		PA7		PA5		PA3		PA1	
APORT2X	BUSBX	PB15		PB13		PB11		PB9				PB5		PB3		PB1		PA15		PA13		PA11		PA9		PA7		PA5		PA3		PA1	
APORT2Y	BUSBY		PB14		PB12		PB10				PB6		PB4		PB2		PB0		PA14		PA12		PA10		PA8		PA6		PA4		PA2		PA0
APORT3X	BUSCX		PF14		PF12		PF10		PF8		PF6		PF4		PF2		PF0		PE14		PE12		PE10		PE8		PE6		PE4				PE0
APORT3Y	BUSCY	PF15		PF13		PF11		PF9		PF7		PF5		PF3		PF1		PE15		PE13		PE11		PE9		PE7		PE5				PE1	
APORT4X	BUSDX	PF15		PF13		PF11		PF9		PF7		PF5		PF3		PF1		PE15		PE13		PE11		PE9		PE7		PE5				PE1	
APORT4Y	BUSDY		PF14		PF12		PF10		PF8		PF6		PF4		PF2		PF0		PE14		PE12		PE10		PE8		PE6		PE4				PE0

Port	Bus	CH31	CH30	CH29	CH28	CH27	CH26	CH25	CH24	CH23	CH22	CH21	CH20	CH19	CH18	CH17	CH16	CH15	CH14	CH13	CH12	CH11	CH10	CH9	CH8	CH7	CH6	CH5	CH4	CH3	CH2	CH1	CH0
OPA2_OUT																																	
APORT4Y	BUSDY		PF14		PF12		PF10		PF8		PF6		PF4		PF2		PF0		PE14		PE12		PE10		PE8		PE6		PE4				PE0
APORT3Y	BUSCY	PF15		PF13		PF11		PF9		PF7		PF5		PF3		PF1		PE15		PE13		PE11		PE9		PE7		PE5				PE1	
APORT2Y	BUSBY		PB14		PB12		PB10				PB6		PB4		PB2		PB0		PA14		PA12		PA10		PA8		PA6		PA4		PA2		PA0
APORT1Y	BUSAY	PB15		PB13		PB11		PB9				PB5		PB3		PB1		PA15		PA13		PA11		PA9		PA7		PA5		PA3		PA1	
OPA2_P																																	
APORT1X	BUSAX		PB14		PB12		PB10				PB6		PB4		PB2		PB0		PA14		PA12		PA10		PA8		PA6		PA4		PA2		PA0
APORT2X	BUSBX	PB15		PB13		PB11		PB9				PB5		PB3		PB1		PA15		PA13		PA11		PA9		PA7		PA5		PA3		PA1	
APORT3X	BUSCX		PF14		PF12		PF10		PF8		PF6		PF4		PF2		PF0		PE14		PE12		PE10		PE8		PE6		PE4				PE0
APORT4X	BUSDX	PF15		PF13		PF11		PF9		PF7		PF5		PF3		PF1		PE15		PE13		PE11		PE9		PE7		PE5				PE1	
OPA3_N																																	
APORT1Y	BUSAY	PB15		PB13		PB11		PB9				PB5		PB3		PB1		PA15		PA13		PA11		PA9		PA7		PA5		PA3		PA1	
APORT2Y	BUSBY		PB14		PB12		PB10				PB6		PB4		PB2		PB0		PA14		PA12		PA10		PA8		PA6		PA4		PA2		PA0
APORT3Y	BUSCY	PF15		PF13		PF11		PF9		PF7		PF5		PF3		PF1		PE15		PE13		PE11		PE9		PE7		PE5				PE1	
APORT4Y	BUSDY		PF14		PF12		PF10		PF8		PF6		PF4		PF2		PF0		PE14		PE12		PE10		PE8		PE6		PE4				PE0

6.2 BGA192 PCB Land Pattern

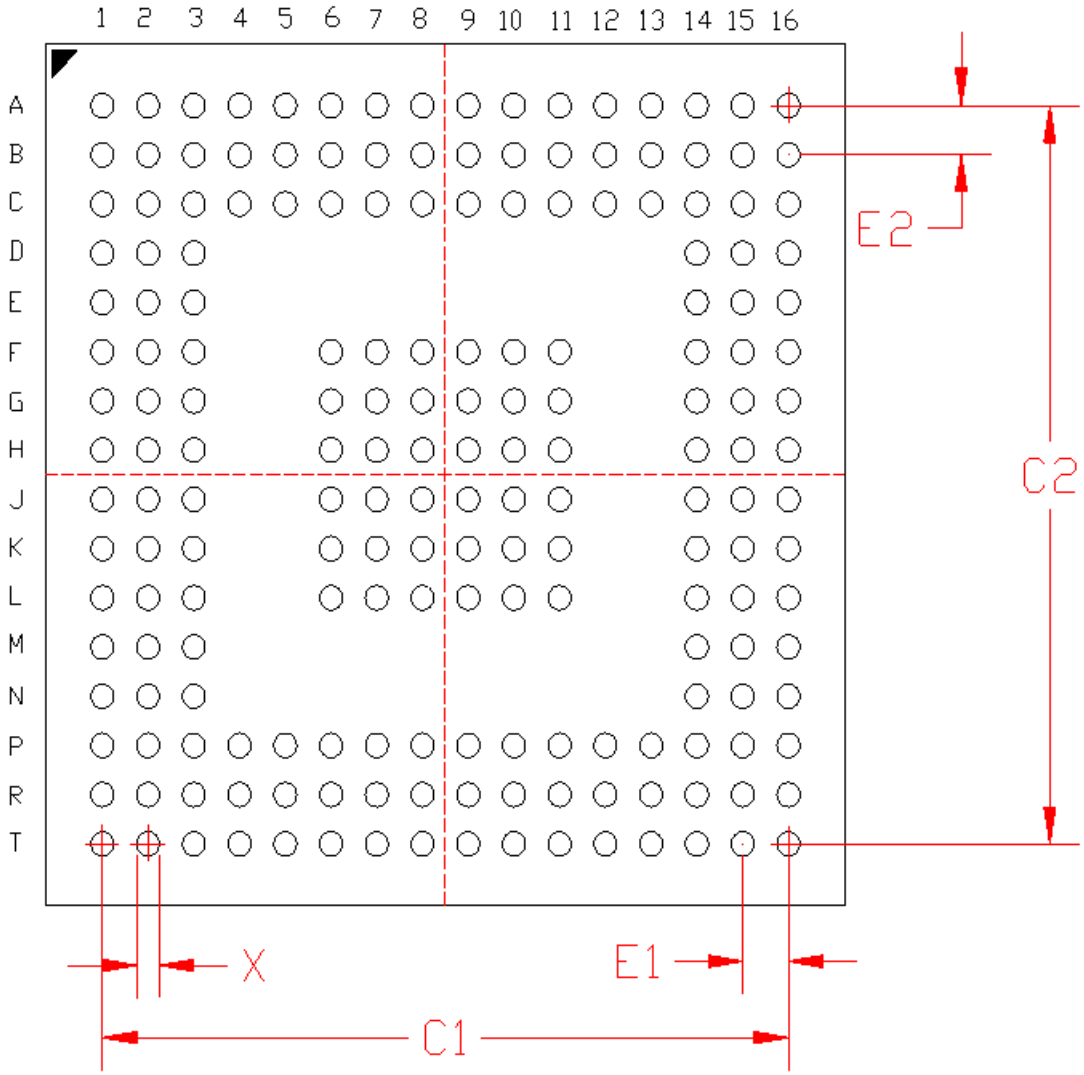

Figure 6.2. BGA192 PCB Land Pattern Drawing

6.3 BGA192 Package Marking

Figure 6.3. BGA192 Package Marking

The package marking consists of:

- PPPPPPPPPP – The part number designation.
- TTTTTT – A trace or manufacturing code. The first letter is the device revision.
- YY – The last 2 digits of the assembly year.
- WW – The 2-digit workweek when the device was assembled.

8. BGA120 Package Specifications

8.1 BGA120 Package Dimensions

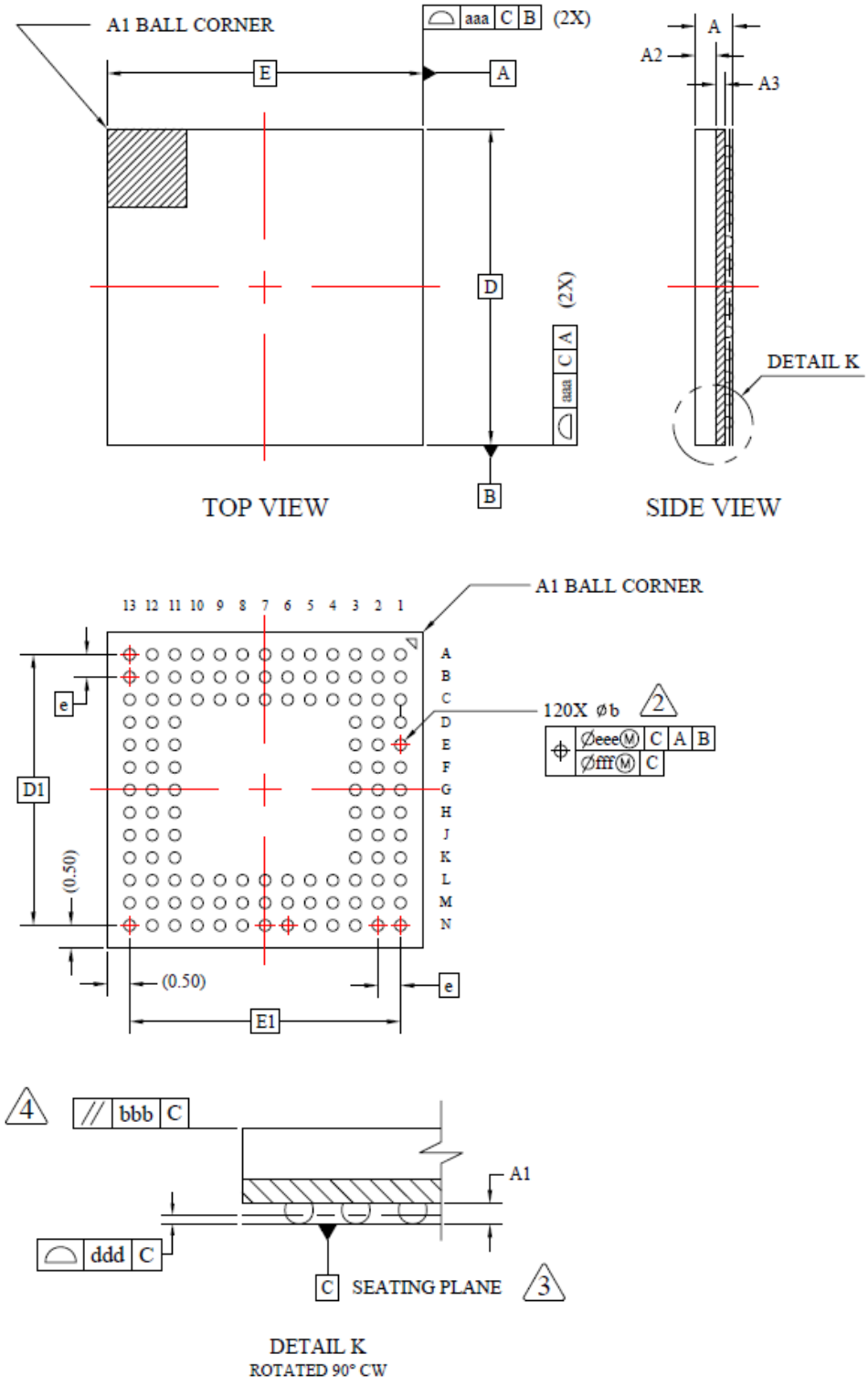

Figure 8.1. BGA120 Package Drawing

9.2 BGA112 PCB Land Pattern

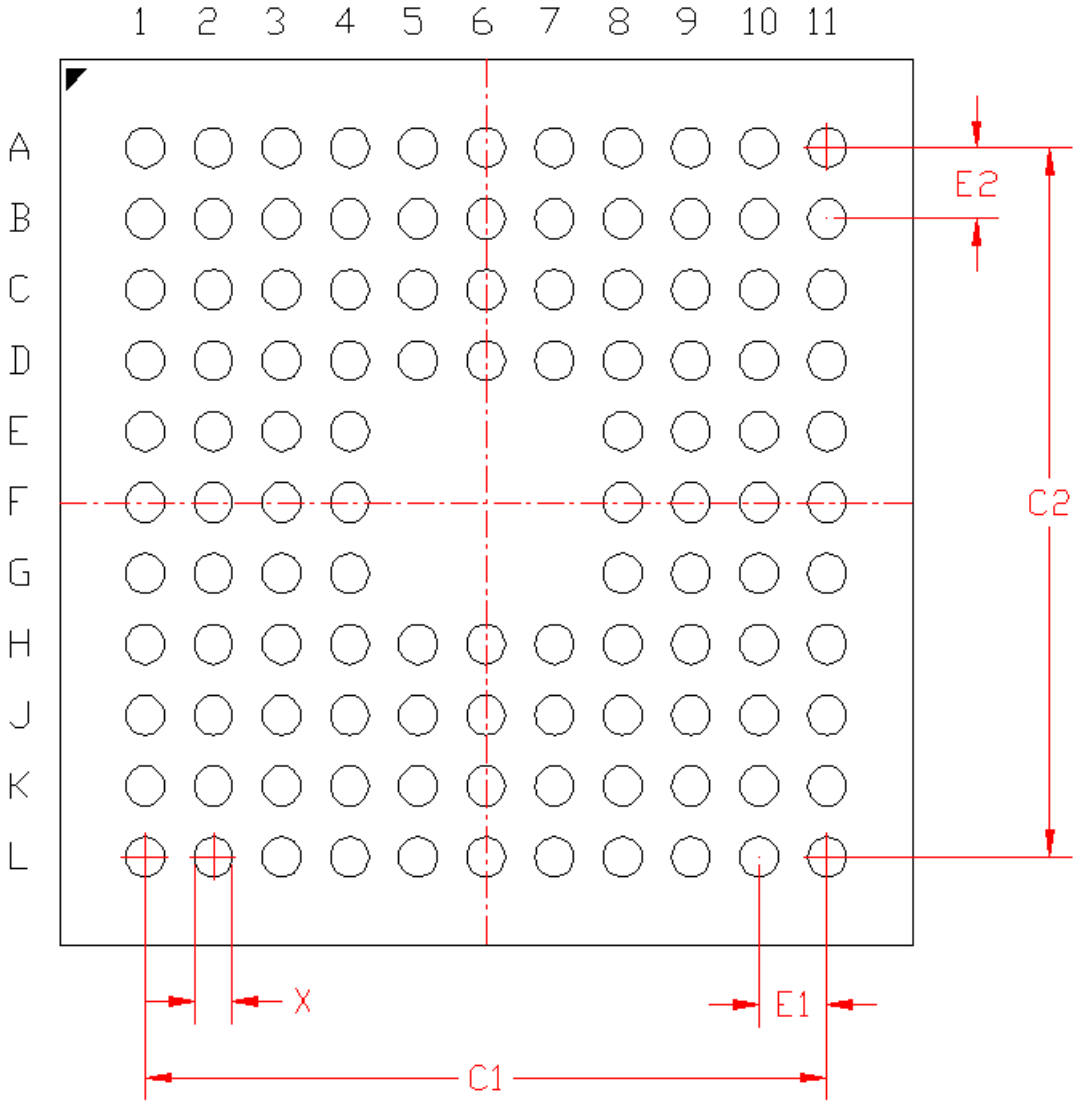

Figure 9.2. BGA112 PCB Land Pattern Drawing

11. TQFP64 Package Specifications

11.1 TQFP64 Package Dimensions

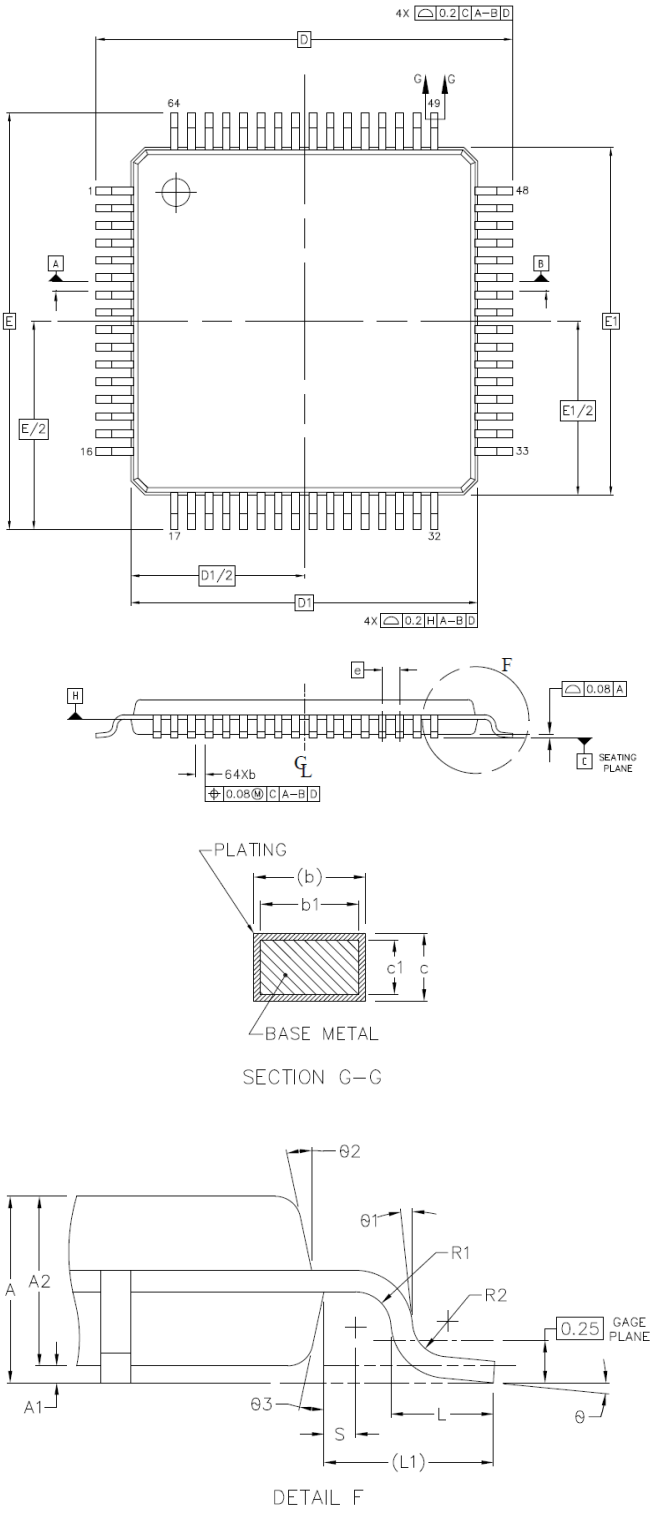

Figure 11.1. TQFP64 Package Drawing